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Articles in the February 1991 Issue (Vol. 6, No. 2)

⁵¹V and ⁹³Nb High Resolution NMR Study of NbVO₅, by J. Davis, D. Tinet, J.J. Fripiat, J.M. Amarilla, B. Casal, and E. Ruiz-Hitzky.

A Microstructural Study of a Ni₂AlTi-Ni(Al,Ti)-Ni₃(Al,Ti) Three-Phase Alloy, by R. Yang, J.A. Leake, and R.W. Cahn.

A Quasicrystalline Transition State in an Annealed Al₆₅-Cu₂₀Fe₁₅ Alloy, by Z. Zhang, N.C. Li, and K. Urban.

Aerosol Processing of YBaCuO Superconductors in a Flame Reactor, by Michael R. Zachariah and Serge Huzarewicz.

Bridged Macrocyclic Transition Metal Complexes, a New Type of Semiconducting Materials, by Michael Hanack, A. Hirsch, A. Lange, M. Rein, G. Renz, and P. Vermehren.

Cu Deposition on Rough Ceramic Substrate: Physical Structure, Microstructure, and Resistivity, by P. Bai, J.F. McDonald, and T.-M. Lu.

Diffusion Barrier Development for Fiber-Reinforced Ni₃Al Composites, by P.C. Brennan, J.-M. Yang, W.H. Kao, and H.A. Katzman.

Dislocation Density Reduction in Heteroepitaxial III-V Compound Films on Si Substrates for Optical Devices, by Masafumi Yamaguchi.

Effect of Ternary Additions on the Structural Stability and Electronic Structure of Intermetallic Compounds: Al₃Ti + Cu, by T. Hong and A.J. Freeman.

Fabrication of YBa₂Cu₃O_{7-x} Superconducting Bulk with Aligned Microstructure by Sintering Technique, by S.R. Su, M. O'Connor, and M. Levinson.

First Principles Calculation of the Elastic Constants of Intermetallic Compounds: Metastable Al₃Li, by X.-Q. Guo, R. Podloucky, and A.J. Freeman.

Gel-Derived Amorphous Cesium-Aluminosilicate Powders Useful for Formation of Pollucite Glass-Ceramics, by Mari A. Hogan and Subhash H. Risbud.

Internal Friction due to Oxygen Relaxation in Superconducting YBa₂Cu₃O_{7-δ} Above T_c, by James R. Cost and James T. Stanley.

Magnetic Domains around Annealed Shear Bands and Embrittlement of FeBSi Metallic Glass, by V. Lakshmanan and J.C.M. Li.

Microscratch and Load Relaxation Tests for Ultra-Thin Films, by T.W. Wu.

Microstructural Characterization of YBaCuO Thin Films Deposited by RF Magnetron Sputtering as a Function of Annealing Conditions, by M. Ece, R.W. Vook, and John P. Allen.

Ni/YBa₂Cu₃O_{7-x} and Ni/Bi₂Sr₂Ca_{0.8}Y_{0.2}Cu₂O_x Interface Formation: Reactivity, Segregation, and Chemical Trapping, by H.M. Meyer III, D.M. Hill, J.H. Weaver, K.C. Goretta, and U. Balachandran.

Particle-Size Control in Tetramethylammonium-Carbonate-Coprecipitated YBa₂Cu₃O₇, by Nicholas D. Spencer, Thorvald S. Peders, and Matthew B. Baer.

Properties of the Liquid-Vapor Interface of fcc Metals Calculated Using the Embedded Atom Method, by L.M. Holzman, J.B. Adams, S.M. Foiles, and W.N.G. Hitchon.

Rapid Solidification of Ni₃Al by Osprey Deposition, by D.G. Morris and M.A. Morris.

Site Selectivity of Mn Atoms in Gamma-TiAl Alloys Determined by X-ray Scattering, by V. Suresh Babu and Mohindar S. Seehra.

Structural Evolution in Lead Substituted Bi-Sr-Ca-Cu-O Superconductors, by R. Ramesh, K. Remschnig, J.M. Tarascon, and S.M. Green.

Studies of Weight Changes and Oxygen Diffusion in Ceramic Superconductors, by S.-F. Lau, A.B. Rosenthal, N.P. Pyrras, J.A. Graham, and H.N. Cheng.

Synthesis, Characterization, and Potential Application of Highly Chemically Durable Glasses Based on AlF₃, by Tariq Iqbal, Mahmoud R. Shahriari, Glenn Merberg, and George H. Sigel, Jr.

The Evolution of Damage in Tritium Exposed Copper, by S.H. Goods.

The Interaction between Dislocations and Intergranular Cracks, by H. Zhang, A.H. King, and R. Thomson.

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